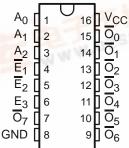
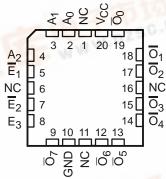
SCCS013B - MAY 1994 - REVISED OCTOBER 2001

- Function, Pinout, and Drive Compatible
   With FCT and F Logic
- Reduced V<sub>OH</sub> (Typically = 3.3 V) Versions of Equivalent FCT Functions
- Edge-Rate Control Circuitry for Significantly Improved Noise Characteristics
- I<sub>off</sub> Supports Partial-Power-Down Mode Operation
- Matched Rise and Fall Times
- Fully Compatible With TTL Input and Output Logic Levels
- Dual 1-of-8 Decoder With Enables
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)
  - 1000-V Charged-Device Model (C101)
- CY54FCT138T
  - 32-mA Output Sink Current
  - 12-mA Output Source Current
- CY74FCT138T
  - 64-mA Output Sink Current
  - 32-mA Output Source Current

#### CY54FCT138T... D PACKAGE CY74FCT138T... Q OR SO PACKAGE (TOP VIEW)



CY54FCT138T . . . L PACKAGE (TOP VIEW)



NC - No internal connection

## description

The 'FCT138T devices are 1-of-8 decoders. These devices accept three binary weighted inputs (A<sub>0</sub>, A<sub>1</sub>, A<sub>2</sub>) and, when enabled, provide eight mutually exclusive active-low outputs  $(\overline{O}_0 - \overline{O}_7)$ . The 'FCT138T devices feature three enable inputs: two active low  $(\overline{E}_1, \overline{E}_2)$  and one active high  $(E_3)$ .

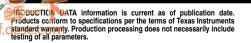
All outputs are high unless  $\overline{E}_1$  and  $\overline{E}_2$  are low and  $E_3$  is high. This multiple-enable function allows easy parallel expansion of the device to a 1-of-32 (five lines to 32 lines) decoder with just four 'FCT138T devices and one inverter.

These devices are fully specified for partial-power-down applications using I<sub>off</sub>. The I<sub>off</sub> circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

#### PIN DESCRIPTION

NAME	DESCRIPTION
Α	Address inputs
$\overline{E}_1, \overline{E}_2$	Enable inputs (active low)
E <sub>3</sub>	Enable input (active high)
ō	Outputs

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.





#### **ORDERING INFORMATION**

TA	PACI	KAGE†	SPEED (ns)	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	QSOP - Q	Tape and reel	5	CY74FCT138CTQCT	FT138-3
	SOIC - SO	Tube	5	CY74FCT138CTSOC	FCT138C
	3010 - 30	Tape and reel	5	CY74FCT138CTSOCT	FC1136C
–40°C to 85°C	QSOP - Q	Tape and reel	5.8	CY74FCT138ATQCT	FT138-1
	SOIC - SO	Tube	5.8	CY74FCT138ATSOC	FCT138A
	3010 - 30	Tape and reel	5.8	CY74FCT138ATSOCT	FULLSOA
	QSOP - Q	Tape and reel	9	CY74FCT138TQCT	FT138
	LCC – L	Tube	6	CY54FCT138CTLMB	
–55°C to 125°C	LCC – L	Tube	12	CY54FCT138TLMB	
	CDIP – D	Tube	12	CY54FCT138TDMB	

<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

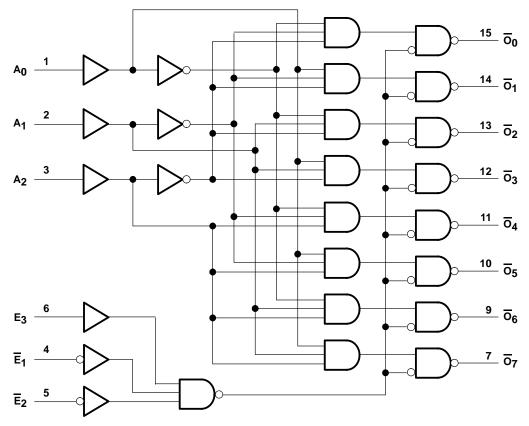
#### **FUNCTION TABLE**

		INP	UTS						OUTI	PUTS			
E <sub>1</sub>	E <sub>2</sub>	E <sub>3</sub>	A <sub>0</sub>	A <sub>1</sub>	A <sub>2</sub>	$\overline{O}_0$	<u>0</u> 1	02	03	04	<u>0</u> 5	<u>0</u> 6	<del>0</del> 7
Н	Х	Χ	Χ	Х	Х	Н	Н	Н	Н	Н	Н	Н	Н
Х	Н	X	X	Χ	X	Н	Н	Н	Н	Н	Н	Н	Н
Х	Χ	L	Χ	Χ	X	Н	Н	Н	Н	Н	Н	Н	Н
L	L	Н	L	L	L	L	Н	Н	Н	Н	Н	Н	Н
L	L	Н	Н	L	L	Н	L	Н	Н	Н	Н	Н	Н
L	L	Н	L	Н	L	Н	Н	L	Н	Н	Н	Н	Н
L	L	Н	Н	Н	L	Н	Н	Н	L	Н	Н	Н	Н
L	L	Н	L	L	Н	Н	Н	Н	Н	L	Н	Н	Н
L	L	Н	Н	L	Н	Н	Н	Н	Н	Н	L	Н	Н
L	L	Н	L	Н	Н	Н	Н	Н	Н	Н	Н	L	Н
L	L	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	L

H = High logic level, L = Low logic level, X = Don't care



### logic diagram (positive logic)



Pin numbers shown are for the D, Q, and SO packages.

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range to ground potential	–0.5 V to 7 V
DC input voltage range	–0.5 V to 7 V
DC output voltage range	–0.5 V to 7 V
DC output current (maximum sink current/pin)	120 mA
Package thermal impedance, θ <sub>JA</sub> (see Note 1): Q package	90°C/W
SO package	57°C/W
Ambient temperature range with power applied, T <sub>A</sub>	–65°C to 135°C
Storage temperature range, T <sub>stq</sub>	–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The package thermal impedance is calculated in accordance with JESD 51-7.



## CY54FCT138T, CY74FCT138T 1-OF-8 DECODERS

SCCS013B - MAY 1994 - REVISED OCTOBER 2001

#### recommended operating conditions (see Note 2)

		CY	54FCT13	8T	CY74FCT138T			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
VIH	High-level input voltage	2			2			V
$V_{IL}$	Low-level input voltage			0.8			0.8	V
ЮН	High-level output current			-12			-32	mA
loL	Low-level output current			32			64	mA
TA	Operating free-air temperature	-55		125	-40		85	°C

NOTE 2: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETER	TEGT CONDITIONS	CY	54FCT13	8T	CY	74FCT13	8T			
PARAMETER	TEST CONDITIONS	MIN	TYP†	MAX	MIN	TYP†	MAX	UNIT		
Voice	$V_{CC} = 4.5 \text{ V}, \qquad I_{IN} = -18 \text{ mA}$		-0.7	-1.2				V		
VIK	$V_{CC} = 4.75 \text{ V}, \qquad I_{IN} = -18 \text{ mA}$					-0.7	-1.2	V		
	$V_{CC} = 4.5 \text{ V}, \qquad I_{OH} = -12 \text{ mA}$	2.4	3.3							
Voн	$V_{CC} = 4.75 \text{ V}$ $I_{OH} = -32 \text{ mA}$				2			V		
	$I_{OH} = -15 \text{ mA}$				2.4	3.3				
V <sub>OL</sub>	$V_{CC} = 4.5 \text{ V}, \qquad I_{OL} = 32 \text{ mA}$		0.3	0.55				V		
VOL.	$V_{CC} = 4.75 \text{ V}, \qquad I_{OL} = 64 \text{ mA}$					0.3	0.55	V		
$V_{hys}$	All inputs		0.2			0.2		V		
V <sub>CC</sub> =	$V_{CC} = 5.5 \text{ V}, \qquad V_{IN} = V_{CC}$			5				μА		
	$V_{CC} = 5.25 \text{ V}, \qquad V_{IN} = V_{CC}$						5	μπ		
IIH	$V_{CC} = 5.5 \text{ V}, \qquad V_{IN} = 2.7 \text{ V}$			±1				μA		
'1⊓	$V_{CC} = 5.25 \text{ V}, \qquad V_{IN} = 2.7 \text{ V}$						±1	μπ		
IIL	$V_{CC} = 5.5 \text{ V}, \qquad V_{IN} = 0.5 \text{ V}$			±1				μΑ		
'IL	$V_{CC} = 5.25 \text{ V}, \qquad V_{IN} = 0.5 \text{ V}$						±1	μπ		
los‡	$V_{CC} = 5.5 \text{ V}, \qquad V_{OUT} = 0 \text{ V}$	-60	-120	-225				mA		
108+	$V_{CC} = 5.25 \text{ V}, \qquad V_{OUT} = 0 \text{ V}$				-60	-120	-225	111/ (		
l <sub>off</sub>	$V_{CC} = 0 \text{ V}, \qquad V_{OUT} = 4.5 \text{ V}$			±1			±1	μΑ		
l <sub>CC</sub>	$V_{CC} = 5.5 \text{ V}, \qquad V_{IN} \le 0.2 \text{ V}, \qquad V_{IN} \ge V_{CC} - 0.2 \text{ V}$		0.1	0.2				mA		
100	$V_{CC} = 5.25 \text{ V}, \qquad V_{IN} \le 0.2 \text{ V}, \qquad V_{IN} \ge V_{CC} - 0.2 \text{ V}$					0.1	0.2	111/ (		
1100	$V_{CC} = 5.5 \text{ V}, V_{IN} = 3.4 \text{ V}$ , $f_1 = 0$ , Outputs open		0.5	2				mA		
ΔICC	$V_{CC} = 5.25 \text{ V}, V_{IN} = 3.4 \text{ V}$ , $f_1 = 0$ , Outputs open					0.5	2	IIIA		
loop¶	$V_{CC}$ = 5.5 V, Outputs open, One bit switching at 50% duty cycle, VIN $\leq$ 0.2 V or VIN $\geq$ VCC $-$ 0.2 V		0.06	0.12				mA/		
ICCD¶	$V_{CC}$ = 5.25 V, Outputs open, One bit switching at 50% duty cycle, $V_{IN} \le 0.2$ V or $V_{IN} \ge V_{CC} - 0.2$ V			2 2.4 3.3 3 0.55  0.3 0.55 2 0.2 5  ±1  ±1  ±1  0 -225  -60 -120 -225  ±1 ±1  1 0.2  0.1 0.2  6 0.12	0.12	MHz				

<sup>†</sup> Typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

This parameter is derived for use in total power-supply calculations.



Not more than one output should be shorted at a time. Duration of short should not exceed one second. The use of high-speed test apparatus and/or sample-and-hold techniques are preferable to minimize internal chip heating and more accurately reflect operational values. Otherwise, prolonged shorting of a high output can raise the chip temperature well above normal and cause invalid readings in other parametric tests. In any sequence of parameter tests, I<sub>OS</sub> tests should be performed last.

<sup>§</sup> Per TTL-driven input (V<sub>IN</sub> = 3.4 V); all other inputs at V<sub>CC</sub> or GND

SCCS013B - MAY 1994 - REVISED OCTOBER 2001

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted) (continued)

PARAMETER	TEST CONDITIONS			CY	54FCT13	8T	CY	UNIT		
PARAMETER	TEST CONDITIONS				TYP <sup>†</sup>	MAX	MIN	TYP†	MAX	UNII
IC#	$V_{CC} = 5.5 \text{ V},$ Outputs open, Switch $\overline{E}_1$ , $\overline{E}_2$ , or	One output switching at f <sub>1</sub> = 10 MHz	$V_{IN} \le 0.2 \text{ V or}$ $V_{IN} \ge V_{CC} - 0.2 \text{ V}$		0.7	1.4				
	E <sub>3</sub>	at 50% duty cycle	V <sub>IN</sub> = 3.4 V or GND		1	2.4				mA
	V <sub>CC</sub> = 5.25 V, Outputs open,	One output switching at f <sub>1</sub> = 10 MHz	$V_{IN} \le 0.2 \text{ V or}$ $V_{IN} \ge V_{CC} - 0.2 \text{ V}$					0.7	1.4	IIIA
	F <sub>2</sub>	at 50% duty cycle	V <sub>IN</sub> = 3.4 V or GND					1	2.4	
C <sub>i</sub>		•			5	10		5	10	pF
Co					9	12		9	12	pF

<sup>†</sup> Typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ}\text{C}$ .

Where:

IC = Total supply current

I<sub>CC</sub> = Power-supply current with CMOS input levels

 $\Delta I_{CC}$  = Power-supply current for a TTL high input ( $V_{IN}$  = 3.4 V)

 $\begin{array}{ll} D_H &= \text{Duty cycle for TTL inputs high} \\ N_T &= \text{Number of TTL inputs at } D_H \end{array}$ 

I<sub>CCD</sub> = Dynamic current caused by an input transition pair (HLH or LHL)

f<sub>0</sub> = Clock frequency for registered devices, otherwise zero

f<sub>1</sub> = Input signal frequency

N<sub>1</sub> = Number of inputs changing at f<sub>1</sub>

All currents are in milliamperes and all frequencies are in megahertz.

|| Values for these conditions are examples of the I<sub>CC</sub> formula.

#### switching characteristics over operating free-air temperature range (see Figure 1)

PARAMETER	FROM	то	CY54FC	T138T	CY54FC1	UNIT	
	(INPUT)	(OUTPUT)	MIN	MAX	MIN	MAX	UNII
<sup>t</sup> PLH	А	ō	1.5	12	1.5	6	ne
t <sub>PHL</sub>		U	1.5	12	1.5	6	ns
<sup>t</sup> PLH	EE	ō	1.5	12.5	1.5	6.1	20
t <sub>PHL</sub>	$\overline{E}_1$ or $\overline{E}_2$	U	1.5	12.5	1.5	6.1	ns
<sup>t</sup> PLH	Ea	ō	1.5	12.5	1.5	6.1	ne
t <sub>PHL</sub>	E <sub>3</sub>		1.5	12.5	1.5	6.1	ns

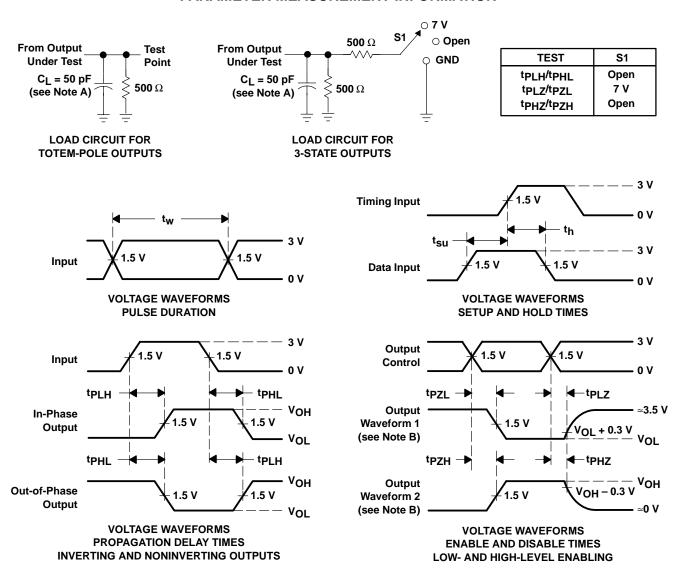
## switching characteristics over operating free-air temperature range (see Figure 1)

PARAMETER	FROM	то	CY74FC	T138T	CY74FC	Г138АТ	CY74FC1	T138CT	UNIT
	(INPUT)	(OUTPUT)	MIN	MAX	MIN	MAX	MIN	MAX	UNII
<sup>t</sup> PLH	A	ō	1.5	9	1.5	5.8	1.5	5	ns
tPHL		A O	1.5	9	1.5	5.8	1.5	5	115
<sup>t</sup> PLH	$\overline{E}_1$ or $\overline{E}_2$	ō	1.5	9	1.5	5.9	1.5	5	no
t <sub>PHL</sub>		0	1.5	9	1.5	5.9	1.5	5	ns
<sup>t</sup> PLH	-	ō	1.5	9	1.5	5.9	1.5	5	no
<sup>t</sup> PHL	E <sub>3</sub>	U	1.5	9	1.5	5.9	1.5	5	ns



 $<sup>^{\#}</sup>$ IC = ICC +  $\triangle$ ICC  $\times$  DH  $\times$  NT + ICCD (f<sub>0</sub>/2 + f<sub>1</sub>  $\times$  N<sub>1</sub>)

#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



#### **IMPORTANT NOTICE**

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third—party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Mailing Address:

Texas Instruments
Post Office Box 655303
Dallas, Texas 75265